

https://www.phoenixcontact.com/us/products/1156939



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SMD pin header, nominal current: 3 A, Test voltage: 500 V AC, number of positions: 10, pitch: 2. 54 mm, color: black, contact surface: Au, contact connection type: Pin, mounting: SMD soldering



Your advantages

- · Reliable mechanical and electrical connections thanks to the double-sided contact system
- · Designed for integration into the SMT soldering process
- · Clear and cost-optimized design
- · Suitable for a multitude of applications
- · Stacked, coplanar or orthogonal PCB connections enable maximum flexibility in the device

Commercial data

Item number	1156939
Packing unit	390 pc
Minimum order quantity	390 pc
Sales key	AA24
Product key	AAXGBA
GTIN	4063151159092
Weight per piece (including packing)	1.214 g
Weight per piece (excluding packing)	1.214 g
Customs tariff number	85366930
Country of origin	CN



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Technical data

Notes

Notes on operation	The permissible voltage during operation depends on the application, taking into consideration the air clearances and
	creepage distances within the scope of insulation requirements in accordance with IEC 60664-1.

Product properties

Product type	SMD pin header
Product family	FQ 2,54D/PH
Number of positions	10
Pitch	2.54 mm
Number of rows	2
Pin layout	Linear pad geometry

Data management status

Article revision	00
Afficie revision	

Electrical properties

Nominal current I _N	3 A (at 20°C 80-pos.)
Contact resistance	20 mΩ
Test voltage	500 V AC IEC 60512-4-1:2003

Dimensions

Dimensional drawing	p h
Pitch	2.54 mm
Width [w]	12.7 mm
Height [h]	6.28 mm
Length [I]	16.1 mm
Installed height	5.08 mm
Application	
Contact cover	0.4 mm
Wipe length	1.3 mm
PCB design	
Pad geometry	1.3 x 2.8 mm

Material specifications

Material data - contact



Result

Dimension check

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Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Selective coating
Metal surface contact area (top layer)	Gold (Au)
Metal surface contact area (middle layer)	Nickel (Ni)
Metal surface soldering area (top layer)	Tin (Sn)
aterial data - housing	
Color (Housing)	black (9005)
Insulating material	PA
Insulating material group	1
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0
CTI according to IEC 60112	600
CTI according to IEC 60112 ctrical tests	600
ctrical tests	600
ctrical tests nermal test Test group C	
ctrical tests nermal test Test group C Specification	IEC 60512-5-2:2002-02
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ctrical tests nermal test Test group C Specification Tested number of positions sulation resistance	IEC 60512-5-2:2002-02 80
ctrical tests nermal test Test group C Specification Tested number of positions sulation resistance Specification	IEC 60512-5-2:2002-02 80 IEC 60512-3-1:2002-02
ctrical tests nermal test Test group C Specification Tested number of positions sulation resistance Specification Insulation resistance, neighboring positions	IEC 60512-5-2:2002-02 80 IEC 60512-3-1:2002-02
ctrical tests nermal test Test group C Specification Tested number of positions sulation resistance Specification Insulation resistance, neighboring positions r clearances and creepage distances	IEC 60512-5-2:2002-02 80 IEC 60512-3-1:2002-02 > 1 GΩ
ctrical tests nermal test Test group C Specification Tested number of positions sulation resistance Specification Insulation resistance, neighboring positions r clearances and creepage distances Insulating material group Minimum value for clearance and creepage distance	IEC 60512-5-2:2002-02 80 IEC 60512-3-1:2002-02 > 1 GΩ
ctrical tests nermal test Test group C Specification Tested number of positions sulation resistance Specification Insulation resistance, neighboring positions r clearances and creepage distances Insulating material group	IEC 60512-5-2:2002-02 80 IEC 60512-3-1:2002-02 > 1 GΩ
ctrical tests nermal test Test group C Specification Tested number of positions sulation resistance Specification Insulation resistance, neighboring positions r clearances and creepage distances Insulating material group Minimum value for clearance and creepage distance chanical tests	IEC 60512-5-2:2002-02 80 IEC 60512-3-1:2002-02 > 1 GΩ
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ctrical tests nermal test Test group C Specification Tested number of positions sulation resistance Specification Insulation resistance, neighboring positions r clearances and creepage distances Insulating material group Minimum value for clearance and creepage distance chanical tests sertion and withdrawal forces	IEC 60512-5-2:2002-02 80 IEC 60512-3-1:2002-02 > 1 GΩ I 0.4 mm
etrical tests nermal test Test group C Specification Tested number of positions sulation resistance Specification Insulation resistance, neighboring positions r clearances and creepage distances Insulating material group Minimum value for clearance and creepage distance chanical tests sertion and withdrawal forces Result	IEC 60512-5-2:2002-02 80 IEC 60512-3-1:2002-02 > 1 GΩ I 0.4 mm
ctrical tests nermal test Test group C Specification Tested number of positions sulation resistance Specification Insulation resistance, neighboring positions r clearances and creepage distances Insulating material group Minimum value for clearance and creepage distance chanical tests sertion and withdrawal forces Result No. of cycles	IEC 60512-5-2:2002-02 80 IEC 60512-3-1:2002-02 > 1 GΩ I 0.4 mm Test passed 100
ctrical tests nermal test Test group C Specification Tested number of positions sulation resistance Specification Insulation resistance, neighboring positions r clearances and creepage distances Insulating material group Minimum value for clearance and creepage distance chanical tests sertion and withdrawal forces Result No. of cycles Insertion strength per pos. approx. Withdraw strength per pos. approx.	IEC 60512-5-2:2002-02 80 IEC 60512-3-1:2002-02 > 1 GΩ I 0.4 mm Test passed 100 2.9 N
ctrical tests nermal test Test group C Specification Tested number of positions sulation resistance Specification Insulation resistance, neighboring positions r clearances and creepage distances Insulating material group Minimum value for clearance and creepage distance chanical tests sertion and withdrawal forces Result No. of cycles Insertion strength per pos. approx.	IEC 60512-5-2:2002-02 80 IEC 60512-3-1:2002-02 > 1 GΩ I 0.4 mm Test passed 100 2.9 N

Test passed



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Packaging specifications

Type of packaging



0 15 11	JEO 00540 4 0 0000 00
Specification	IEC 60512-1-2:2002-02
Result	Test passed
vironmental and real-life conditions	
vironimental and roal inc conditions	
/ibration test	
Specification	IEC 60068-2-6:2007-12
Frequency	10 - 55 - 10 Hz
Sweep speed	1 octave/min
Amplitude	1.52 mm
Acceleration	181 m/s²
Test duration per axis	2 h
Test directions	X-, Y- and Z-axis
Durability test	
Specification	IEC 60512-9-1:2010-03 (following)
Contact resistance R ₁	20 mΩ
Contact resistance R ₂	30 mΩ
Insertion/withdrawal cycles	100
Insulation resistance, neighboring positions	> 1 GΩ
Ambient conditions	
Ambient temperature (operation)	-40 °C 125 °C
Ambient temperature (storage/transport)	-40 °C 70 °C
Relative humidity (storage/transport)	30 % 70 %
Ambient temperature (assembly)	-5 °C 100 °C
unting	
punting	
Mounting type	SMD soldering
Pin layout	Linear pad geometry
Processing notes	
Process	Reflow soldering
Moisture Sensitive Level	MSL 1
Classification temperature T _c	260 °C

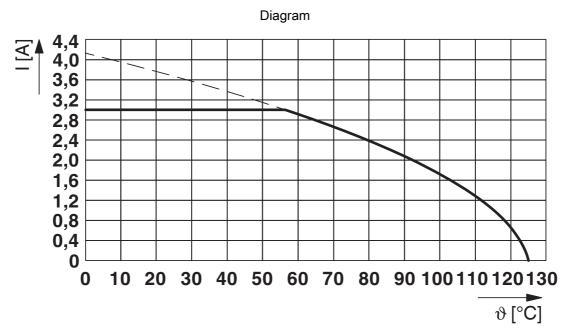
Tube magazine



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Drawings



Type: FQ 2,54D/...-SH-O-BT with FQ 2,54D/...-PH-1-BT



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Approvals

To download certificates, visit the product detail page: https://www.phoenixcontact.com/us/products/1156939

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		Nominal voltage U_N	Nominal current I _N	Cross section AWG	Cross section mm ²
		30 V	3 A	-	-



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Classifications

UNSPSC 21.0

ECLASS

ECLASS-11.0	27460201
ECLASS-13.0	27460201
ECLASS-12.0	27460201
ETIM	
ETIM 9.0	EC002637
UNSPSC	

39121400



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Environmental product compliance

EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions
China RoHS	
Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits
EU REACH SVHC	
REACH candidate substance (CAS No.)	No substance above 0.1 wt%

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